Electronic Patent Application Fee Transmittal								
Application Number:	107	10773968						
Filing Date:	06-	06-Feb-2004						
Title of Invention:	Device and method for forming improved resist layer							
First Named Inventor/Applicant Name:	Paul D. Shirley							
Filer:	John Reed/Evelyn Gaddis							
Attorney Docket Number:	MIO 0112 PA/40509.272							
Filed as Large Entity								
Utility under 35 USC 111(a) Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Notice of appeal		1401	1	540	540			
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			540